

**ABSTRACT OF THE DISCLOSURE****HIGHLY ANTISTATIC LAMINATE**

A highly antistatic laminate containing a substrate and a conductive layer laminated on at least one side of the substrate, the conductive layer containing a conductive polymer and being cured, wherein a surface resistance ( $RS_0$ ) at 25°C, relative humidity 15% of the conductive layer is not more than  $10^{11} \Omega / \square$ , a ratio ( $RS_1/RS_0$ ) of surface resistance ( $RS_1$ ) at 25°C, relative humidity 15% of the conductive layer after immersing the highly antistatic laminate in pure water at 40°C for one hour, to  $RS_0$  is not more than 10, and a ratio ( $RS_2/RS_0$ ) of surface resistance ( $RS_2$ ) at 25°C, relative humidity 15% of the conductive layer after 150% stretching the highly antistatic laminate, to  $RS_0$  is preferably not more than 10.

The highly antistatic laminate of the present invention provides a highly antistatic laminate having superior transparency, resistance to blocking and antistatic property under low humidity, after immersion in water and after forming, which certainly prevents occurrence of static electricity under any environment.